**Product data sheet** 

### 1. General description

Planar Low  $V_F$  Schottky barrier rectifier encapsulated in a CFP15B (SOT1289B) power and flat lead Surface-Mounted Device (SMD) plastic package.

### 2. Features and benefits

- · Very low forward voltage
- High power capability due to clip-bonding technology
- Small and thin SMD plastic package
- Qualified according to AEC-Q101 and recommended for use in automotive applications

## 3. Applications

- · High efficiency DC-to-DC conversion
- · Low voltage rectification
- Switch mode power supply
- · Freewheeling application
- · Reverse polarity protection
- OR-ing

### 4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I <sub>F(AV)</sub>	average forward current	$\delta$ = 0.5; f = 20 kHz; square wave; T <sub>sp</sub> $\leq$ 174 °C		-	-	3	А
V <sub>R</sub>	reverse voltage	T <sub>j</sub> = 25 °C		-	-	50	V
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 3 A; pulsed; T <sub>j</sub> = 25 °C	[1]	-	460	530	mV
I <sub>R</sub>	reverse current	$V_R$ = 50 V; pulsed; $T_j$ = 25 °C	[1]	-	35	100	μΑ

<sup>[1]</sup> Very short pulse, in order to maintain a stable junction temperature.

## 5. Pinning information

**Table 2. Pinning information** 

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	Α	anode	5	
2	A	anode		K A
3	K	cathode		aaa-009063
			CFP15B (SOT1289B)	



# 6. Ordering information

#### **Table 3. Ordering information**

Type number	Package		
	Name	Description	Version
PMEG050V030EPE-Q		plastic, thermal enhanced ultra thin SMD package; 3 leads; 2.13 mm pitch; 5.8 x 4.3 x 0.95 mm body	SOT1289B

## 7. Marking

#### Table 4. Marking codes

Type number	Marking code
PMEG050V030EPE-Q	050V U03E

# 8. Limiting values

### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>R</sub>	reverse voltage	T <sub>j</sub> = 25 °C		-	50	V
I <sub>F</sub>	forward current	$\delta$ = 1; $T_{sp} \le 173 ^{\circ}\text{C}$		-	4.2	А
I <sub>F(AV)</sub>	average forward current	$\delta$ = 0.5; f = 20 kHz; square wave; T <sub>sp</sub> ≤ 174 °C		-	3	A
I <sub>FSM</sub>	non-repetitive peak forward current	half sine-wave pulse; $t_p$ = 8.3 ms; $T_{j(init)}$ = 25 °C		-	120	A
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C	[1]	-	1.66	W
			[2]	-	2.15	W
Tj	junction temperature			-	175	°C
T <sub>amb</sub>	ambient temperature			-55	175	°C
T <sub>stg</sub>	storage temperature			-65	175	°C

<sup>[1]</sup> Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

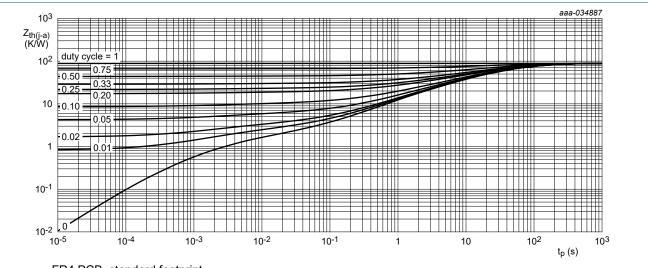
<sup>[2]</sup> Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.

## 9. Thermal characteristics

**Table 6. Thermal characteristics** 

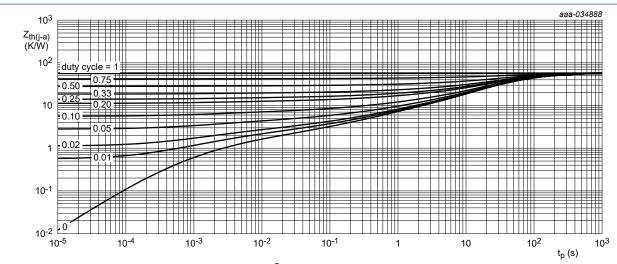
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R <sub>th(j-a)</sub>	thermal resistance from	in free air	[1] [2]	-	-	90	K/W
junction to ambient		[1] [3]	-	-	70	K/W	
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point		[4]	-	-	3	K/W

- [1] For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses P<sub>R</sub> are a significant part of the total power losses.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.
- [4] Soldering point of cathode tab.



FR4 PCB, standard footprint

Fig. 1. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



FR4 PCB, mounting pad for cathode 1 cm<sup>2</sup>

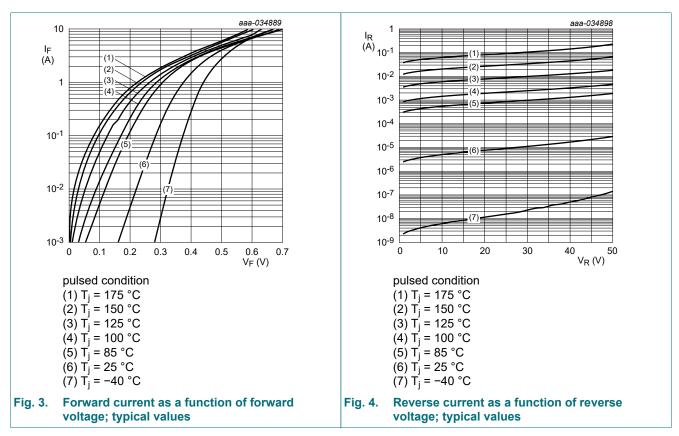
Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

### 10. Characteristics

**Table 7. Characteristics** 

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V <sub>(BR)R</sub>	reverse breakdown voltage	$I_R = 3 \text{ mA}$ ; pulsed; $T_j = 25 \text{ °C}$	[1]	50	-	-	V
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 1 A; pulsed; T <sub>j</sub> = 25 °C	[1]	-	375	400	mV
		I <sub>F</sub> = 2 A; pulsed; T <sub>j</sub> = 25 °C	[1]	-	420	500	mV
		I <sub>F</sub> = 3 A; pulsed; T <sub>j</sub> = 25 °C	[1]	-	460	530	mV
		I <sub>F</sub> = 3 A; pulsed; T <sub>j</sub> = -40 °C	[1]	-	505	600	mV
		I <sub>F</sub> = 3 A; pulsed; T <sub>j</sub> = 125 °C	[1]	-	400	490	mV
I <sub>R</sub>	reverse current	V <sub>R</sub> = 50 V; pulsed; T <sub>j</sub> = 25 °C	[1]	-	35	100	μΑ
C <sub>d</sub>	diode capacitance	V <sub>R</sub> = 1 V; f = 1 MHz; T <sub>j</sub> = 25 °C		-	323	-	pF
		V <sub>R</sub> = 10 V; f = 1 MHz; T <sub>j</sub> = 25 °C		-	113	-	pF
t <sub>rr</sub>	reverse recovery time step recovery	$I_F = 0.5 \text{ A}; I_R = 0.5 \text{ A}; I_{R(meas)} = 0.1 \text{ A};$ $T_j = 25 \text{ °C}$		-	12	-	ns
	reverse recovery time ramp recovery	$dI_F/dt = 100 \text{ A/}\mu\text{s}; I_F = 3 \text{ A}; V_R = 30 \text{ V}$		-	10	-	ns
$V_{FRM}$	peak forward recovery voltage	$I_F = 0.5 \text{ A}; \text{ d}I_F/\text{d}t = 20 \text{ A/}\mu\text{s}; T_j = 25 ^{\circ}\text{C}$		-	344	-	mV

[1] Very short pulse, in order to maintain a stable junction temperature.



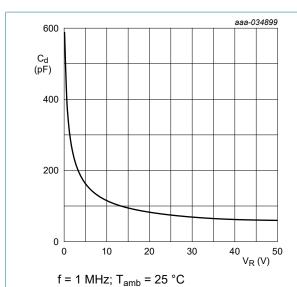
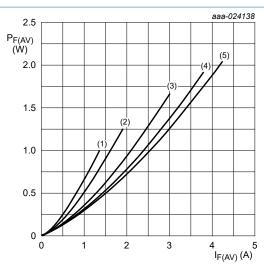
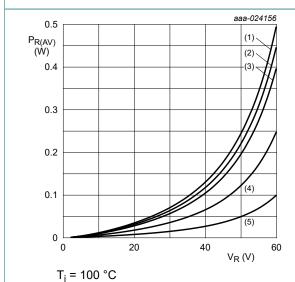


Fig. 5. Diode capacitance as a function of reverse voltage; typical values



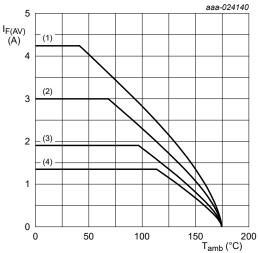
 $T_j = 100 \,^{\circ}\text{C}$   $(1) \, \delta = 0.1$   $(2) \, \delta = 0.2$   $(3) \, \delta = 0.5$   $(4) \, \delta = 0.8$  $(5) \, \delta = 1$ 

Fig. 6. Average forward power dissipation as a function of average forward current; typical values



 $(1) \delta = 1$   $(2) \delta = 0.9$   $(3) \delta = 0.8$   $(4) \delta = 0.5$  $(5) \delta = 0.2$ 

Fig. 7. Average reverse power dissipation as a function of reverse voltage; typical values



FR4 PCB, standard footprint

 $T_j = 175 \,^{\circ}\text{C}$ 

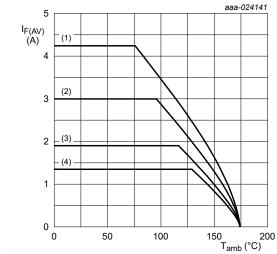
 $(1) \delta = 1; DC$ 

(2)  $\delta$  = 0.5; f = 20 kHz

(3)  $\delta = 0.2$ ; f = 20 kHz

(4)  $\delta = 0.1$ ; f = 20 kHz

Fig. 8. Average forward current as a function of ambient temperature; typical values



FR4 PCB, mounting pad for cathode 1  $\mbox{cm}^2$ 

 $T_i = 175 \,{}^{\circ}\text{C}$ 

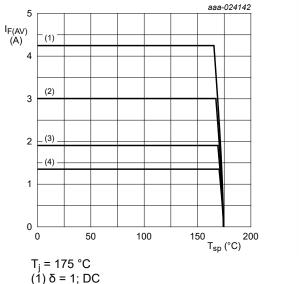
 $(1) \delta = 1$ ; DC

(2)  $\delta = 0.5$ ; f = 20 kHz

(3)  $\delta = 0.2$ ; f = 20 kHz

(4)  $\delta = 0.1$ ; f = 20 kHz

Average forward current as a function of Fig. 9. ambient temperature; typical values



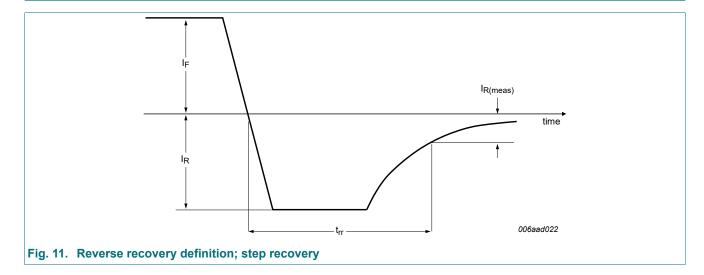
(2)  $\delta = 0.5$ ; f = 20 kHz

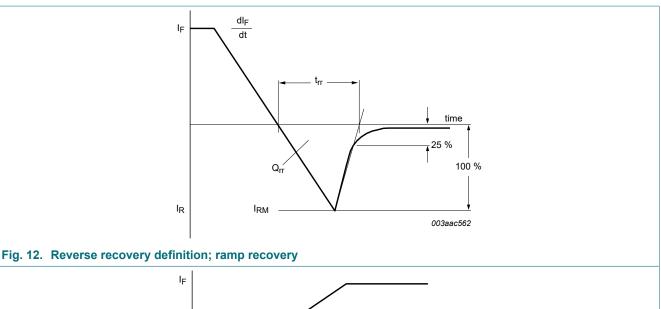
(3)  $\delta = 0.2$ ; f = 20 kHz

 $(4) \delta = 0.1$ ; f = 20 kHz

Fig. 10. Average forward current as a function of solder point temperature; typical values

### 11. Test information





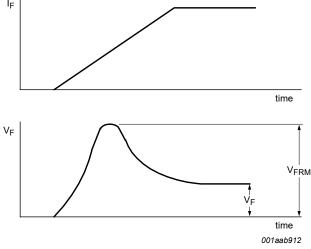


Fig. 13. Forward recovery definition

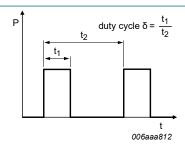


Fig. 14. Duty cycle definition

The current ratings for the typical waveforms are calculated according to the equations:

 $I_{F(AV)} = I_M \times \delta$  with  $I_M$  defined as peak current

 $I_{RMS}=I_{F(AV)}$  at DC, and  $I_{RMS}=I_{M}\times\sqrt{\delta}$ 

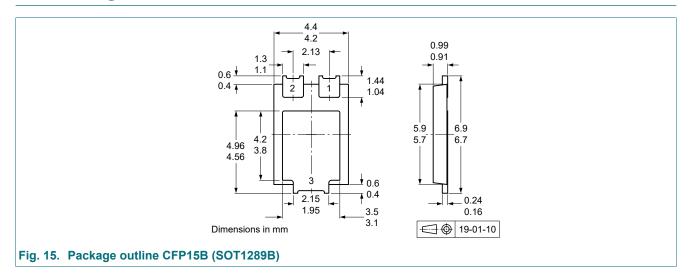
with  $I_{\mbox{\scriptsize RMS}}$  defined as RMS current.

### **Quality information**

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

PMEG050V030EPE-Q

# 12. Package outline



## 13. Soldering

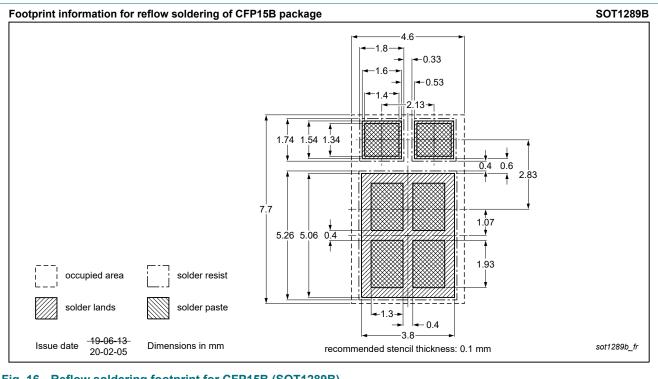


Fig. 16. Reflow soldering footprint for CFP15B (SOT1289B)

# 14. Revision history

#### Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes			
PMEG050V030EPE-Q v.2	20220720	Product data sheet	-	PMEG050V030EPE-Q v.1			
Modifications:	Changed doc	Changed document status to "Product data sheet"					
PMEG050V030EPE-Q v.1	20220530	Preliminary data sheet	-	-			

## 15. Legal information

#### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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